

# Surface Mount Schottky Power Rectifier

Plastic SOD-123 Package

## MBR0530, NRVB0530

The MBR0530 uses the Schottky Barrier principle with a large area metal-to-silicon power diode. Ideally suited for low voltage, high frequency rectification or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. This package also provides an easy to work with alternative to leadless 34 package style. These state-of-the-art devices have the following features:

### Features

- Guardring for Stress Protection
- Low Forward Voltage
- 125°C Operating Junction Temperature
- Epoxy Meets UL 94, V-0 @ 0.125 in
- Package Designed for Optimal Automated Board Assembly
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant\*

### Mechanical Characteristics

- Polarity Designator: Cathode Band
- Weight: 11.7 mg (approximately)
- Case: Epoxy, Molded
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

SCHOTTKY BARRIER  
RECTIFIER  
0.5 AMPERES  
30 VOLTS



SOD-123  
CASE 425  
STYLE 1

### MARKING DIAGRAM



B3 = Device Code  
M = Date Code  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

### ORDERING INFORMATION

Device	Package	Shipping†
MBR0530T1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel **
NRVB0530T1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel **
MBR0530T3G	SOD-123 (Pb-Free)	10,000 / Tape & Reel ***

### DISCONTINUED (Note 1)

NRVB0530T3G	SOD-123 (Pb-Free)	10,000 / Tape & Reel ***
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\*\* 8 mm Tape, 7" Reel

\*\*\* 8 mm Tape, 13" Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

1. **DISCONTINUED:** This device is not recommended for new design. Please contact your onsemi representative for information. The most current information on this device may be available on [www.onsemi.com](http://www.onsemi.com).

\*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# MBR0530, NRVB0530

## MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	30	V
Average Rectified Forward Current (Rated $V_R$ , $T_L = 100^\circ\text{C}$ )	$I_{F(AV)}$	0.5	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	$I_{FSM}$	5.5	A
Storage Temperature Range	$T_{stg}$	-65 to +150	$^\circ\text{C}$
Operating Junction Temperature	$T_J$	-65 to +125	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	dv/dt	1000	V/ $\mu\text{s}$
ESD Rating: Machine Model = C Human Body Model = 3B		> 400 > 8000	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance – Junction-to-Ambient (Note 2)	$R_{\theta JA}$	206	$^\circ\text{C}/\text{W}$
Thermal Resistance – Junction-to-Lead	$R_{\theta JL}$	150	$^\circ\text{C}/\text{W}$

2. 1 inch square pad size (1 x 0.5 inch for each lead) on FR4 board.

## ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 3) ( $i_F = 0.1$ Amps, $T_J = 25^\circ\text{C}$ ) ( $i_F = 0.5$ Amps, $T_J = 25^\circ\text{C}$ )	$V_F$	0.375 0.43	V
Maximum Instantaneous Reverse Current (Note 3) (Rated DC Voltage, $T_C = 25^\circ\text{C}$ ) ( $V_R = 15$ V, $T_C = 25^\circ\text{C}$ )	$I_R$	130 20	$\mu\text{A}$

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

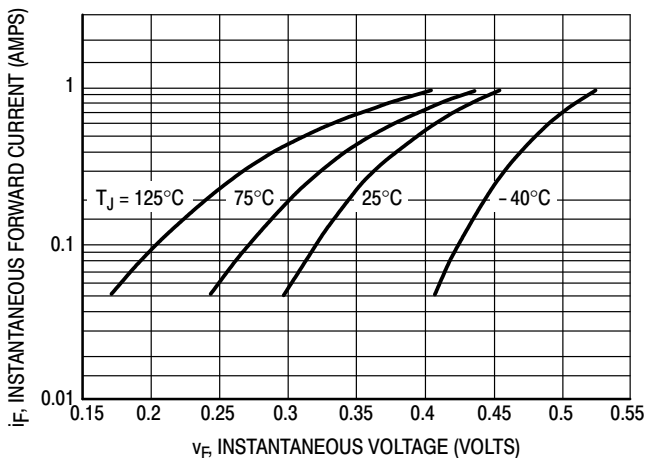


Figure 1. Typical Forward Voltage

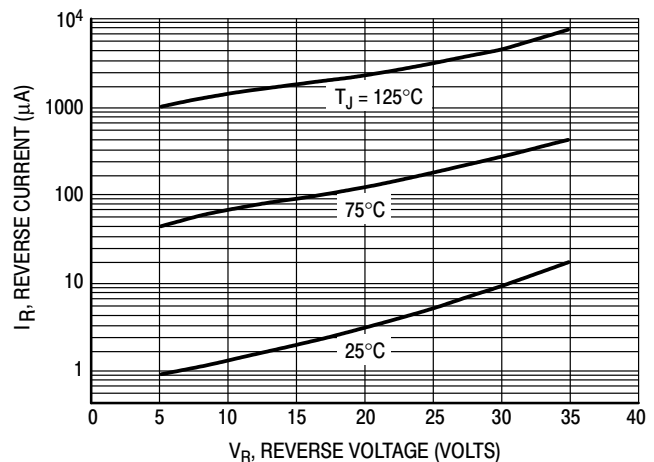


Figure 2. Typical Reverse Current

# MBR0530, NRVB0530

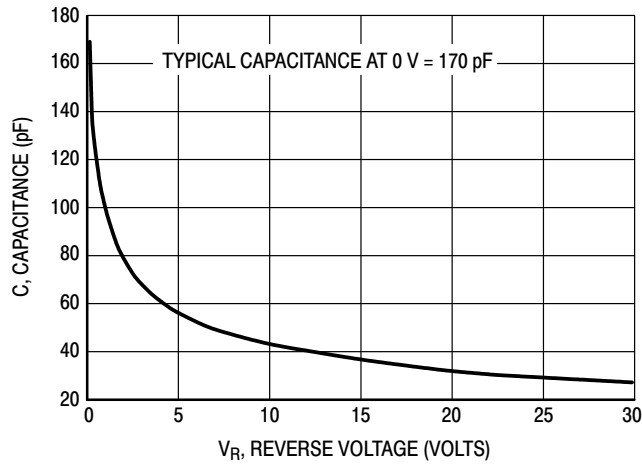


Figure 3. Typical Capacitance

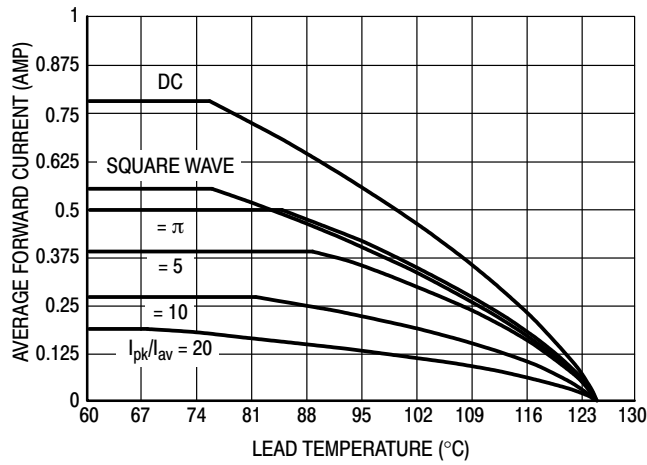


Figure 4. Current Derating (Lead)

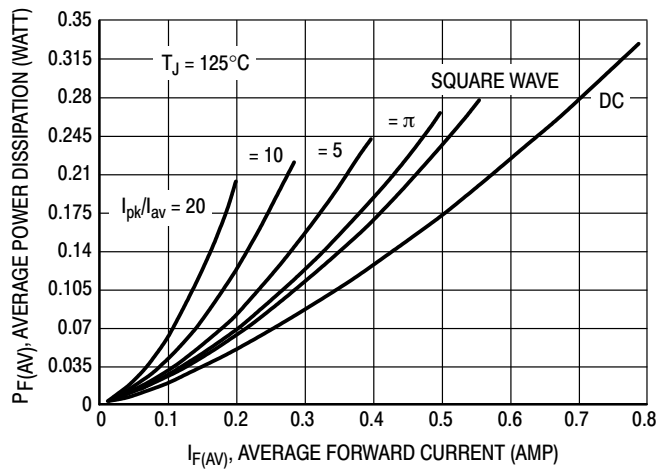
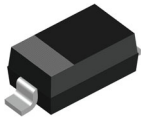
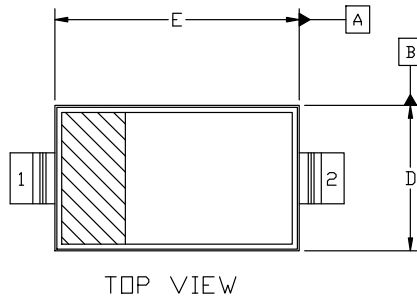


Figure 5. Power Dissipation  
PACKAGE DIMENSIONS

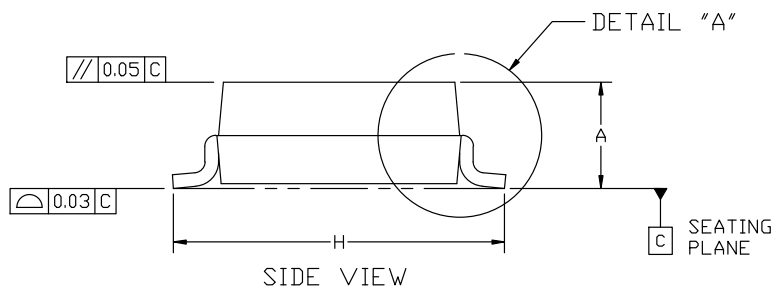


SOD-123 2-LEAD, 1.60x2.69x1.16  
CASE 425  
ISSUE H

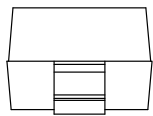
DATE 29 FEB 2024



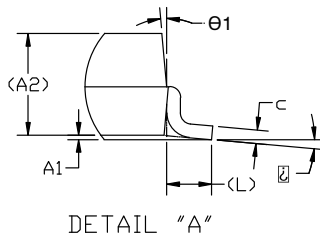
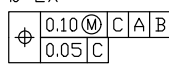
TOP VIEW



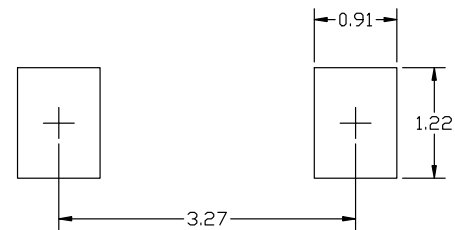
SIDE VIEW



END VIEW



DETAIL "A"



RECOMMENDED MOUNTING FOOTPRINT

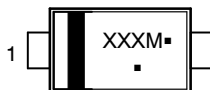
\*For additional information on or Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference manual SOLDERM/D.

NOTES:

1. DIMENSION AND TOLERANCING PER ASME Y14.5M, 2018
2. CONTROLLING DIMENSION: MILLIMETERS

DIM	MILLIMETER		
	MIN.	NOM.	MAX.
A	0.94	1.17	1.35
A1	0.00	0.05	0.10
A2	1.16 REF.		
b	0.51	0.61	0.71
c	-	-	0.15
D	1.40	1.60	1.80
E	2.54	2.69	2.84
H	3.56	3.68	3.86
L	0.25 REF.		
∠	0°		10°
θ1	0°		10°

GENERIC MARKING DIAGRAM\*



- XXX = Specific Device Code
- M = Date Code
- = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1:  
PIN 1. CATHODE  
2. ANODE

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DESCRIPTION:	SOD-123 2-LEAD, 1.60x2.69x1.16	PAGE 1 OF 1

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